捷多邦,专业PCB打样工厂,24小时加急出货

July 2008

FAIRCHILD

FGH40N60UFD 600V, 40A Field Stop IGBT

Features

- High current capability
- Low saturation voltage: $V_{CE(sat)} = 1.8V @ I_C = 40A$
- High input impedance
- Fast switching
- RoHS compliant

Applications

Induction Heating, UPS, SMPS, PFC

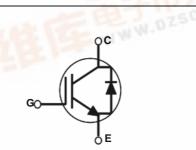


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COLLECTOR (FLANGE)

General Description

Using Novel Field Stop IGBT Technology, Fairchild's new sesries of Field Stop IGBTs offer the optimum performance for Induction Heating, UPS, SMPS and PFC applications where low conduction and switching losses are essential.



Absolute Maximum Ratings

Symbol	Description		Ratings	Units	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		± 20	V	
I _C	Collector Current	@ T _C = 25°C	80	А	
ν υ	Collector Current	@ T _C = 100 ^o C	40	А	
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	120	А	
P _D	Maximum Power Dissipation	@ T _C = 25°C	290	W	
	Maximum Power Dissipation	@ T _C = 100°C	116	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seco		300 300	°C	

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

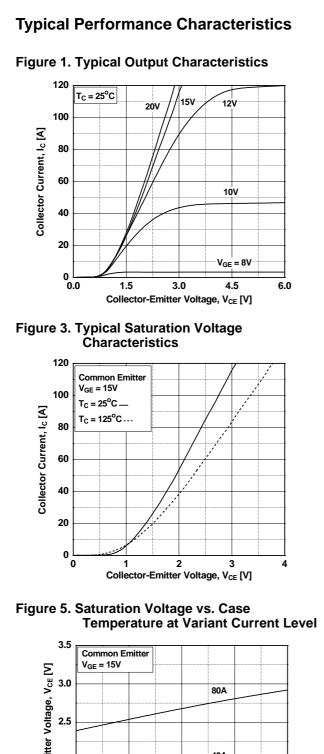
Thermal Characteristics

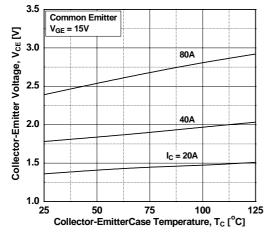
Symbol	Parameter	Тур.	Max.	Units
R _{0JC} (IGBT)	Thermal Resistance, Junction to Case	-	0.43	°C/W
R _{θJC} (Diode)	Thermal Resistance, Junction to Case	-	1.45	°C/W
R _{0JA}	Thermal Resistance, Junction to Ambient	-	40	°C/W

-		Pa	ackage Type TO-247 Tube		Qty per Tube		Max Qty per Box		
		Т						-	
Electric	al Cha	racteristics of t	the IC		°C uplace otherwice poted				
Symbol		Parameter		-	Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics								
BV _{CES}	Collector	to Emitter Breakdown V	oltage	$V_{GE} = 0V, I_{C}$	= 250μA	600	-	-	V
∆BV _{CES}		ure Coefficient of Break	0	$V_{GE} = 0V, I_C = 250 \mu A$ $V_{CE} = 0V, I_C = 250 \mu A$ $V_{CE} = V_{CES}, V_{GE} = 0V$					
ΔT_J	Voltage					-	0.6	-	V/ºC
I _{CES}	Collector	Cut-Off Current				-	-	250	μΑ
I _{GES}	G-E Leak	age Current		$V_{GE} = V_{GES}$	$V_{CE} = \overline{0V}$	-	-	±400	nA
On Charac	teristics								
V _{GE(th)}	1	G-E Threshold Voltage		I _C = 250μA,	V _{CF} = V _{GF}	4.0	5.0	6.5	V
~=(ui)				$I_{\rm C} = 40$ A, $V_{\rm GE} = 15$ V		-	1.8	2.4	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage		$I_{C} = 40A, V_{GE} = 15V,$ $T_{C} = 125^{\circ}C$		-	2.0	-	V	
Dynamic C	haracteris	tics						<u> </u>	
C _{ies}	Input Cap	Capacitance It Capacitance		$V_{CE} = 30V$, $V_{GE} = 0V$, f = 1MHz		-	2110	-	pF
C _{oes}	Output Ca					-	200	-	pF
C _{res}	Reverse Transfer Capacitance					-	60	-	pF
Switching	Characteri	istics							
t _{d(on)}	Turn-On Delay Time				-	24	-	ns	
t _r	Rise Time	ne				-	44	-	ns
t _{d(off)}	Turn-Off I	Delay Time		$V_{CC} = 400V$, $I_C = 40A$, $R_G = 10\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25^{\circ}C$		-	112	-	ns
t _f	Fall Time					-	30	60	ns
Eon	Turn-On S	Switching Loss				-	1.19	-	mJ
E _{off}	Turn-Off	Switching Loss				-	0.46	-	mJ
E _{ts}	Total Swit	ching Loss				-	1.65	-	mJ
t _{d(on)}	Turn-On I	Delay Time				-	24	-	ns
t _r	Rise Time	9				-	45	-	ns
t _{d(off)}	Turn-Off I	Delay Time		V _{CC} = 400V.	= 400V, I _C = 40A,	-	120	-	ns
t _f	Fall Time			R _G = 10Ω, V _{GE} = 15V,		-	40	-	ns
E _{on}	Turn-On S	Switching Loss		Inductive Load, $T_C = 125^{\circ}C$	ad, I _C = 125°C	-	1.2	-	mJ
E _{off}	Turn-Off	Switching Loss				-	0.69	-	mJ
E _{ts}	Total Swit	ching Loss				-	1.89	-	mJ
Qg	Total Gate	e Charge				-	120	-	nC
Q _{ge}	Gate to E	mitter Charge		$V_{CE} = 400V,$	I _C = 40A,	-	14	-	nC
3-	1	-		V _{GE} = 15V		1	<u> </u>	1	

Symbol	Parameter	Test Condition	Min.	Тур.	Max	Units	
V _{FM} D	Diode Forward Voltage	I _F = 20A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	1.95	2.6	V
			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.85	-	
t _{rr} Diode Reverse Recovery Time	Diode Reverse Recovery Time	I _{ES} =20A, dI _{ES} /dt = 200A/μs	T _C = 25°C	-	45	-	ns
			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	140	-	
Q _{rr}	rr Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	75	-	nC
~m			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	375	-	

Electrical Characteristics of the Diode $T_{C} = 25^{\circ}C$ unless otherwise noted





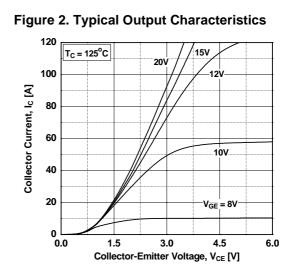


Figure 4. Transfer Characteristics

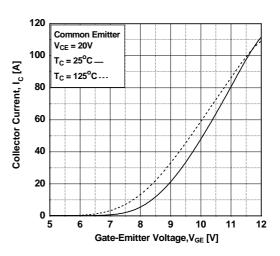
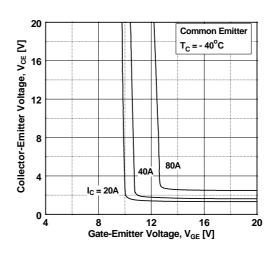
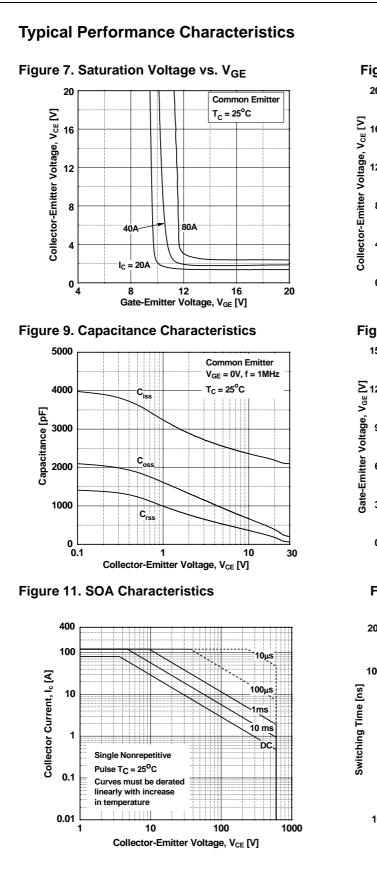
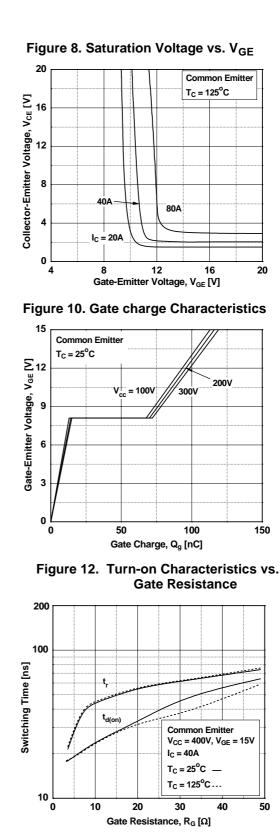


Figure 6. Saturation Voltage vs. V_{GE}







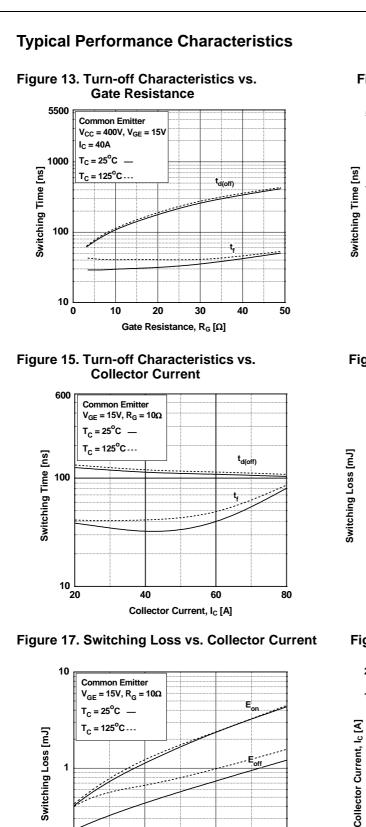


Figure 14. Turn-on Characteristics vs. Collector Current

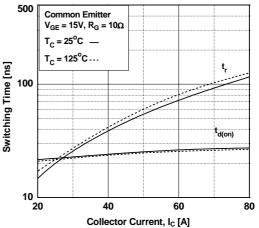


Figure 16. Switching Loss vs. Gate Resistance

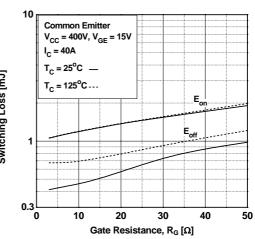
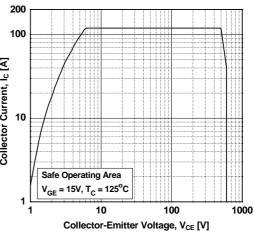


Figure 18. Turn off Switching SOA Characteristics



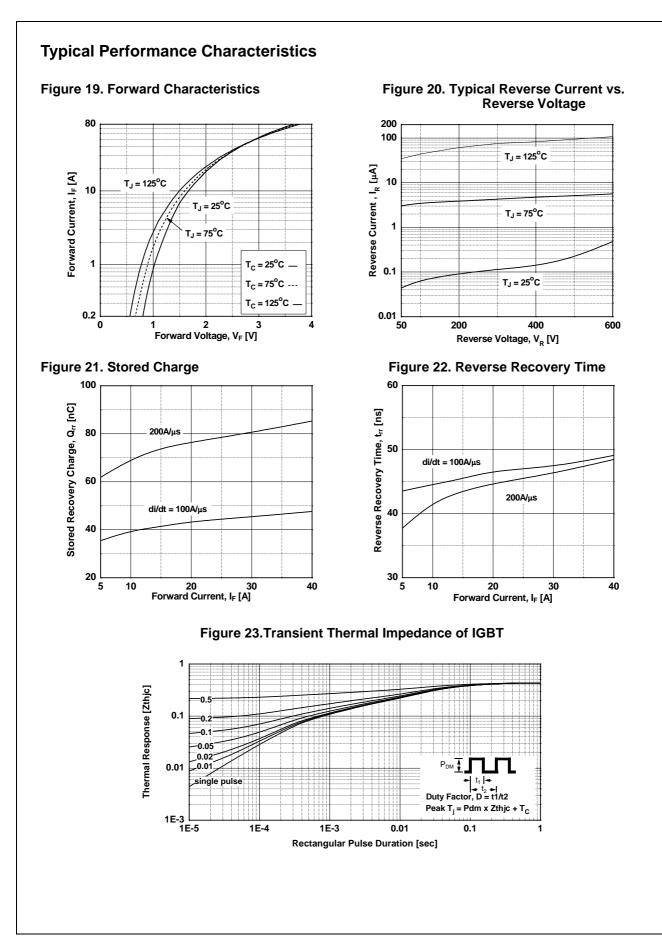
0.1 └ 20

40

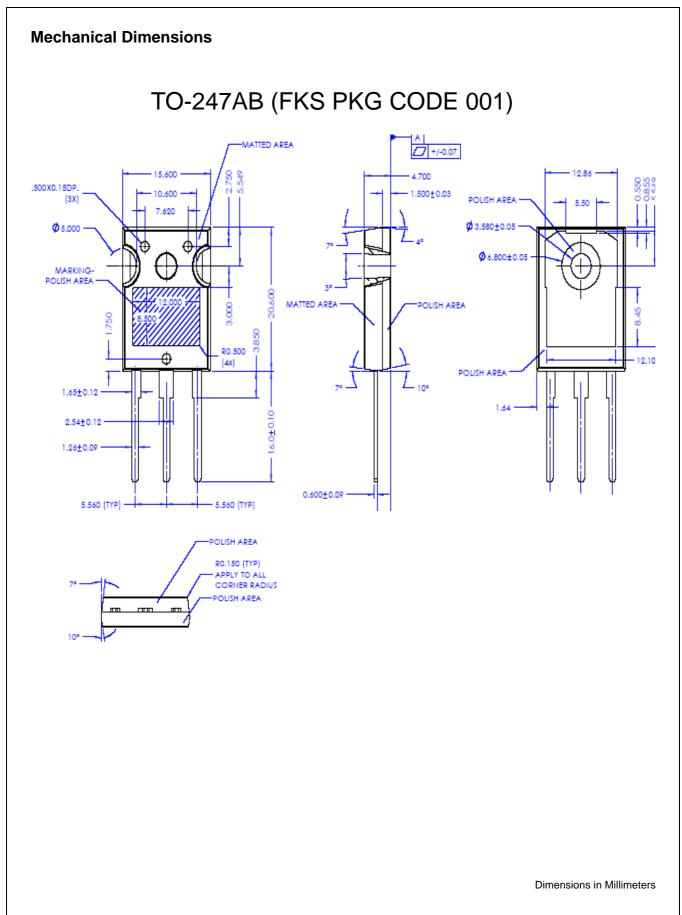
Collector Current, I_C [A]

60

80



FGH40N60UFD Rev. C





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